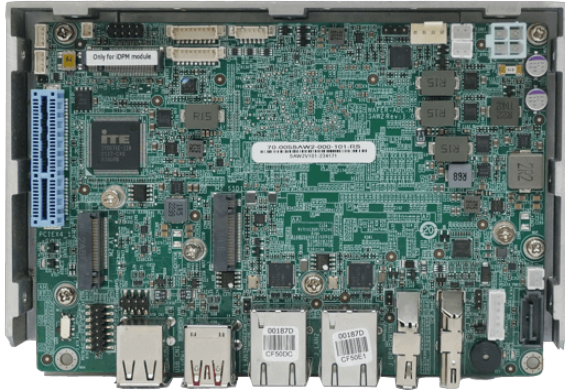


WAFER-ADL-N

3.5 SBC supports Intel® Alder Lake-N/Amston Lake on-board SoC, triple display with DP, HDMI™ and iDPM slot, dual 2.5 GbE, USB 3.2 gen 2, M.2, SATA 6Gb/s, COM and RoHS, -10°C ~ 60°C



Features

- » Support 12th/13th Intel® Alder Lake-N/Amston Lake on board SoC
- » Support on-board LPDDR5x 8GB memory, up to 16GB
- » Support triple independent display via HDMI™, DP and iDPM slot
- » Support PCIe x4 (x2 signal), M.2 M key and M.2 A key expansion
- » Support two 2.5GbE LAN with I225V/I226V

Specifications

| | |
|--------------------------|---|
| Form Factor | |
| Form Factor | 3.5" SBC |
| System | |
| CPU | Intel® Alder Lake-N N97 SoC Processor Intel® Alder Lake-N N200 SoC Processor |
| Memory | Dual channel LPDDR5x 8G pre-installed (system max. 16G) |
| Memory Max. | 16GB |
| Physical Characteristics | |
| Dimensions (LxWxH) (mm) | 146mm x 102mm |
| Net Weight | 350g |
| Storage | |
| Storage | 1 x SATA : 6Gb/s 1 x M.2(NGFF) : 1 x M.2 M Key 2280 (PCIe Gen3 x1) |
| I/O Interface | |
| Display Output | 1 x HDMI™ : up to 4096 x 2160 @ 30Hz 1 x Display Port : up to 4096 x 2160 @ 60Hz 1 x iDPM (only for IEI eDP/LVDS/VGA module) |
| Ethernet | 2 x LAN - LAN1: Intel® I225V/I226V 2.5GbE controller LAN2: Intel® I225V/I226V 2.5GbE controller |
| Audio | 1 x HD Audio : 1 x iAUDIO, support IEI AC-KIT-888S Audio Module (2x5 pin) |
| I/O Interface | 2 x Internal RS-232/422/485 (1x9 pin, P=1.25) 2 x External USB 2.0 (Type A) 2 x Internal USB 2.0 (2x4 pin, P=2.0) 2 x External USB 3.2 Gen2x1 (10Gb/s, Type A) |
| Expansion | 1 x PCIe x4 : PCIe Gen3 x2 signal 2 x M.2(NGFF) - 1 x M.2 A Key 2230 for WIFI & BT (PCIe Gen3 x 1 & USB 2.0) 1 x M.2 M Key 2280 (PCIe Gen3 x1) |
| Power | |
| Power Consumption | 12V@3.21A (Intel® Processor N97 with 8 GB 4800 MHz LPDDR5 memory, max. loading, EuP mode disabled) 12V@2.67A |

| | |
|-----------------------|---|
| | (Intel® Processor N200 with 8 GB 4800 MHz LPDDR5 memory, max. loading, EuP mode disabled) |
| Power Supply | ATX/AT power supply |
| | Support AT/ATX mode |
| | ErP/EuP Compliant |
| Environment | |
| Operating Temperature | -10°C ~ 60°C |
| Storage Temperature | -20°C~70°C |
| Humidity | 5% ~95%, non-condensing |

Ordering Information

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|---------------------|--|
| WAFER-ADL-N97C-R10 | 3.5 SBC supports Intel® Processor N-series N97 SoC Processor , with 8GB LPDDR5x memory on board default, with DP ,HDMI™ iDPM ,dual 2.5 GbE , USB 3.2 gen 2 , M.2, SATA 6Gb/s, COM,PCIe x4 for riser card and RoHS |
| WAFER-ADL-N200C-R10 | 3.5 SBC supports Intel® Processor N-series N200 SoC Processor , with 8GB LPDDR5x memory on board default, with DP ,HDMI™ iDPM ,dual 2.5 GbE , USB 3.2 gen 2 , M.2, SATA 6Gb/s, COM,PCIe x4 for riser card and RoHS |

Packing List

| | |
|--|-------------------------------|
| 1 x WAFER-ADL-N SBC with heat spreader | 1 x SATA with power cable kit |
| 1 x QIG | |